These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ2  
These assemblies are ESD sensitive. ESD precautions shall be observed.

ZZ3  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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